

05-13-1999

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ATTY. DOCKET NO: AB-812 USRECORDATION FORM COVER SHEET
PATENTS ONLYU.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

101036844

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Sung Jin Kim

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Anam Semiconductor, Inc.

Internal Address: _____

Street Address: 280-8 Sungsu 2-Ga Sungdong-Ku

City Seoul State Korea ZIP 133-120

Additional name(s) & address(es) attached? ☒ Yes ☐ No

09/305170

3. Nature of Conveyance:

- ☒ Assignment ☐ Merger
- ☐ Security Agreement ☐ Change of Name
- ☐ Other _____

Execution Date: 4/22/99

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 4/22/99

A. Patent Application No.(s) - unknown

Title: Printed Circuit Board With Oval Solder Ball Lands For
BGA Semiconductor Packages

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Alan H. MacPherson

Internal Address: SKJERVEN, MORRILL, MacPHERSON,

FRANKLIN & FRIEL LLP

Street Address: 25 METRO DRIVE, SUITE 700

City SAN JOSE State CA ZIP 95110

6. Total number of applications and patents involved: 1 (one)

7. Total fee (37 CFR 3.41): \$40.00

- ☒ Authorized to be charged to Deposit Account 19-2386
- ☒ Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

DO NOT USE THIS SPACE

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8. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Don C. Lawrence 31,975
Name of Person Signing*Don C. Lawrence*
Signature05/03/1999
Date

Total number of pages comprising cover sheet: 3

RECORDATION FORM COVER SHEET - Page Two

PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Additional name(s) of conveying party(ies):

2. Additional Names and address of receiving party(ies):

Name: Amkor Technology, Inc.

Internal Address: _____

Street Address: 1900 South Price Road

City Chandler State AZ ZIP 85248-1604

Name: _____

Internal Address: _____

Street Address: _____

City _____ State _____ ZIP _____

Name: _____

Internal Address: _____

Street Address: _____

City _____ State _____ ZIP _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Additional Application number(s) or patent number(s):

A. Patent Application No.(s)

B. Patent No.(s)

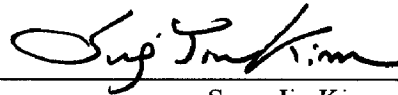
ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, Sung Jin Kim, of 602-1302, Chang-Mi Apt., Hagae 3-Dong, Nowan-Ku, Seoul, Korea, hereby sell, assign and transfer to Anam Semiconductor Inc., a Korean corporation, having a place of business at 280-8 Sungsu 2-GA, Sungdong-Ku, Seoul 133-120 Korea, and Amkor Technology, Inc., a Delaware corporation, having a place of business at 1900 S. Price Road, Chandler, AZ 85248, its successors and assigns, the entire right, title and interest throughout the world in my invention in

Printed Circuit Board With Oval Solder Ball
Lands For BGA Semiconductor Packages

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 22th day of April, 1999.



Sung Jin Kim

WITNESSED:



Signature

Jun Young Yang

Type or Print Name

04/22/99

Date